Tyrone Camarero Specifications

Camarero DS3007R-212RL

Key features

- Dual socket R3 (LGA 2011) supports Intel® Xeon® processor E5-2600 v4/ v3 family; UPI up to 9.6GT/s
- Intel[®] C612 chipset
- Up to 1TB ECC 3DS LRDIMM , up to DDR4- 2400+MHz ; 8x DIMM slots
- 1 PCI-E 3.0 x16, 2 PCI-E 3.0 x8
- Intel[®] i210 Dual GbE LAN ports
- Integrated IPMI 2.0 and KVM with Dedicated LAN
- 8 SAS3 (12Gbps) via Broadcom[®] 3108; HW,RAID 0, 1, 5, 6, 10, 50, 60 SuperCap Option support
- 6 SATA3 (6Gbps) via C232; RAID 0, 1, 5, 10
- 4 USB 3.0 (2 rear, 2 via header)3 USB 2.0 (2 via header, 1 Type A)
- 12 x 3.5" hot-swap drive bay

- 3 x 8cm high-performance PWM fan(s).
- 800W hot swap redundant power supply.

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Processor/Cache		Fro	Front Panel		
Processor	Dual socket R3 (LGA 2011) supports Intel® Xeon® processor E5-2600 v4/ v3 family; UPI up to 9.6GT/s	LE	Ds	2 Network Activity LEDs, Fan Fail/System Over Heat LED, HDD activity LED, Power Status LED, Unit Identification (UID) LED	
Chipset		Bu	uttons	Power On/Off button,System Reset button	
Chipset	Intel [®] C612 chipset	Driv	Drive Bays		
System Memory		HD	D bays	12 x 3.5" hot-swap drive bay	
Memory Capacity	Up to 1TB ⁺ ECC 3DS LRDIMM , up to DDR4- 2400 ⁺ MHz ; 8x DIMM slots				
Expansion Slots		Po	Power Supply		
PCI-Express	1 PCI-E 3.0 x16, 2 PCI-E 3.0 x8	80	800W hot swap redundant power supply.		
Integrated On-Board		Co	Cooling System		
SATA	SATA3 (6Gbps); RAID 0, 1, 5, 10	3 3	3 x 8cm high-performance PWM fan(s)		
SAS	Broadcom 3108 SAS3 (12Gbps) controller;2GB cache with SuperCap backup option; HW RAID 0, 1, 5, 6, 10, 50, 60 ,Supports up to 16 devices as default, more HDD devices support is also available as an option	For	Form Factor		
			orm Factor leight:	2U Rackmount 3.5" (89 mm),	
		W	Vidth:	17.2" (437 mm) <i>,</i>	
LAN	2x RJ45 Gigabit Ethernet LAN ports, 1x RJ45 Dedicated IPMI LAN port	D	epth:	25.5" (647 mm))	
Add-on Options			Email : info@tyronesystems.com		
Optical Drive	None		For more/current product information, visit www.tyronesystems.com		
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